

Product Summary

B120Q/BQ-B140Q/BQ

| V _{RRM} (V) | I _O (A) | V _F Max (V) T _A = +25°C | I _R Max (mA) T _A = +25°C |
|----------------------|--------------------|--|---|
| 20/30/40 | 1.0 | 0.5 | 0.5 |

B150Q/BQ, B160Q/BQ

| V _{RRM} (V) | I _O (A) | V _F Max (V) T _A = +25°C | I _R Max (mA) T _A = +25°C |
|----------------------|--------------------|--|---|
| 50/60 | 1.0 | 0.7 | 0.5 |

Description and Applications

This Schottky Barrier Rectifier is designed to meet the general requirements of commercial applications. It is ideally suited for use as:

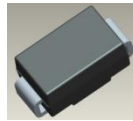
- Polarity Protection Diode
- Re-Circulating Diode
- Switching Diode
- Blocking Diode
- Freewheel Diode

Features and Benefits

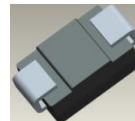
- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 30A Peak
- For Use in Low-Voltage, High-Frequency Inverters
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Notes 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

- Case: SMA & SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (E3)
- Polarity: Cathode Band or Cathode Notch
- Weight:
 - SMA 0.064 grams (Approximate)
 - SMB 0.093 grams (Approximate)



Top View



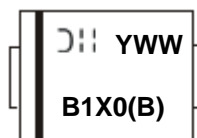
Bottom View

Ordering Information (Note 5)

| Part Number | Qualification | Case | Packaging |
|-------------|---------------|------|-------------------|
| B1X0Q-13-F | Automotive | SMA | 5,000/Tape & Reel |
| B1X0BQ-13-F | Automotive | SMB | 3,000/Tape & Reel |

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



B1X0 = Product Type Marking Code, ex: B140Q (SMA Package)
 B1X0B = Product Type Marking Code, ex: B160BQ (SMB Package)
 D;: = Manufacturers' Code Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 16 for 2016)
 WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load
 For capacitance load, derate current by 20%.

| Characteristic | Symbol | B120Q/BQ | B130Q/BQ | B140Q/BQ | B150Q/BQ | B160Q/BQ | Unit |
|--|---------------------|----------|----------|----------|----------|----------|------|
| Peak Repetitive Reverse Voltage | V _{RRM} | 20 | 30 | 40 | 50 | 60 | V |
| Working Peak Reverse Voltage | V _{RWM} | | | | | | |
| DC Blocking Voltage | V _R | | | | | | |
| RMS Reverse Voltage | V _{R(RMS)} | 14 | 21 | 28 | 35 | 42 | V |
| Average Rectified Output Current @ T _T = +130°C | I _O | 1.0 | | | | | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | 30 | | | | | A |

Thermal Characteristics

| Characteristic | Symbol | B120Q/BQ | B130Q/BQ | B140Q/BQ | B150Q/BQ | B160Q/BQ | Unit |
|--|-----------------------------------|-------------|----------|----------|----------|----------|------|
| Typical Thermal Resistance Junction to Terminal (Note 6) | R _{θJT} | 20 | | | | | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | | | | | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|--|----------------|-----|-----|------------|------|---|
| Forward Voltage Drop B120Q/BQ, B130Q/BQ, B140Q/BQ B150Q/BQ, B160Q/BQ | V _F | — | — | 0.5 0.7 | V | I _F = 1.0A I _F = 1.0A |
| Leakage Current (Note 7) | I _R | — | — | 0.5 10 | mA | @ Rated V _R , T _A = +25°C @ Rated V _R , T _A = +100°C |
| Total Capacitance | C _T | — | — | 110 | pF | V _R = 4V, f = 1MHz |

Notes: 6. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.
 7. Short duration pulse test used to minimize self-heating effect.

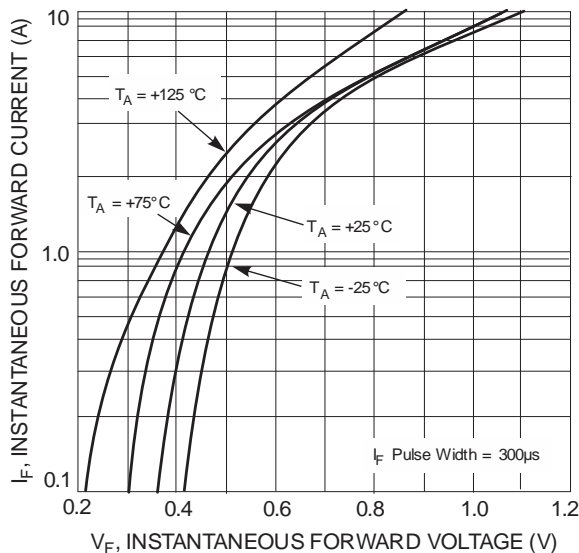


Fig.1 Typical Forward Characteristics - B120Q/BQ thru B140Q/BQ

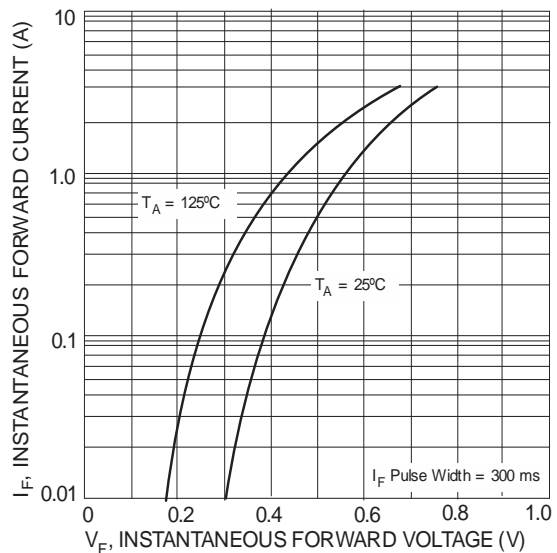


Fig.2 Typical Forward Characteristics - B150Q/BQ thru B160Q/BQ

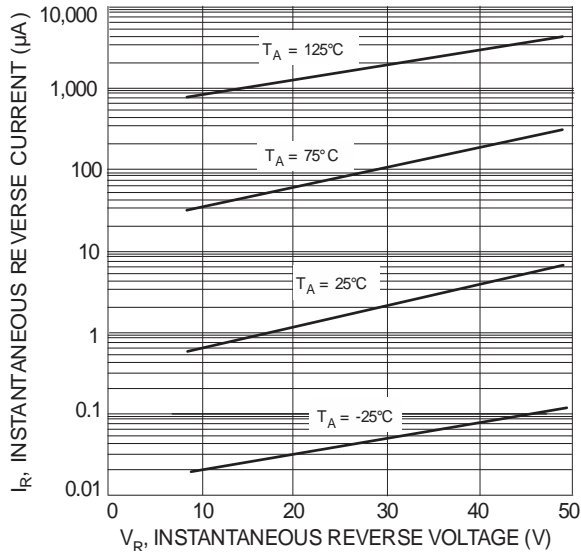


Fig.3 Typical Reverse Characteristics - B120Q/BQ thru B140Q/BQ

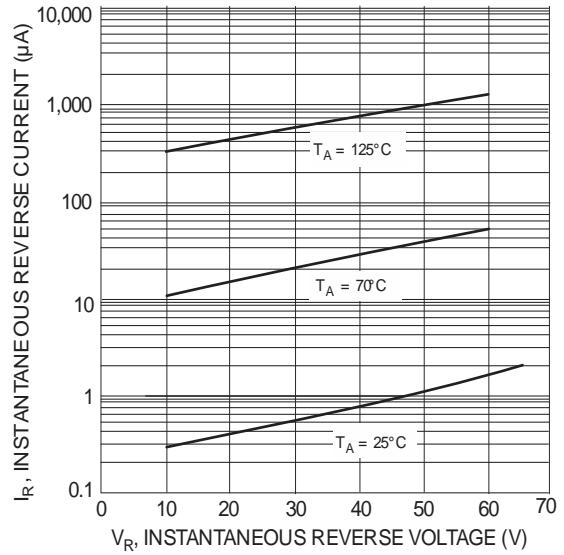


Fig.4 Typical Reverse Characteristics - B150Q/BQ thru B160Q/BQ

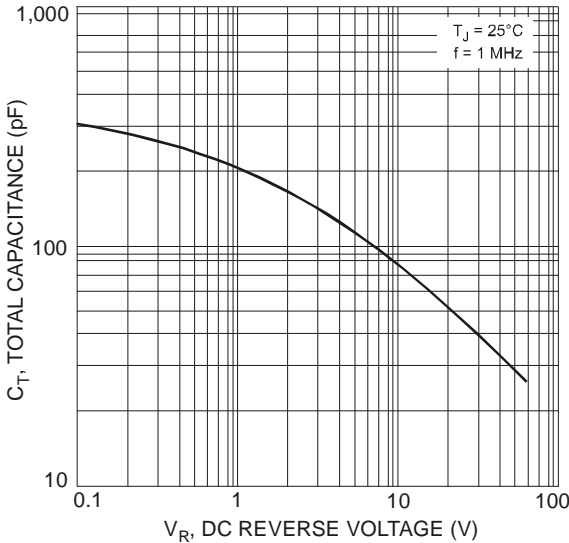


Fig. 5 Total Capacitance vs. Reverse Voltage

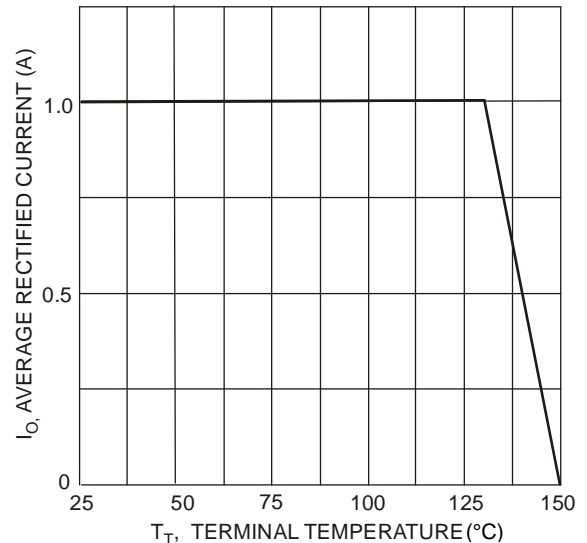


Fig. 6 Forward Current Derating Curve

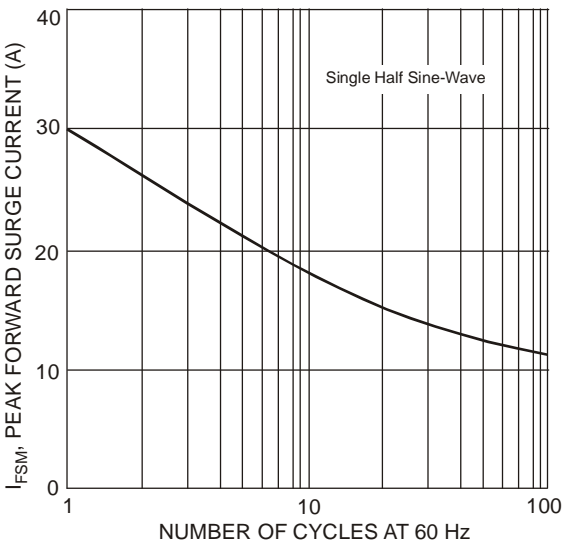
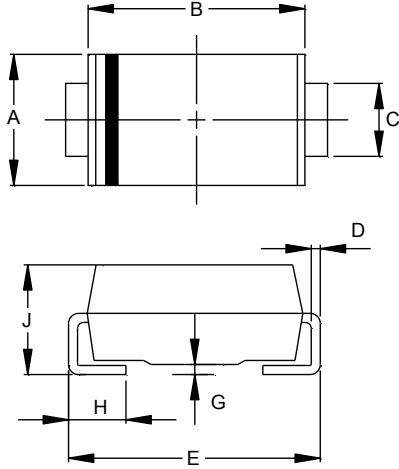


Fig. 7 Max Non-Repetitive Peak Forward Surge Current

Package Outline Dimensions

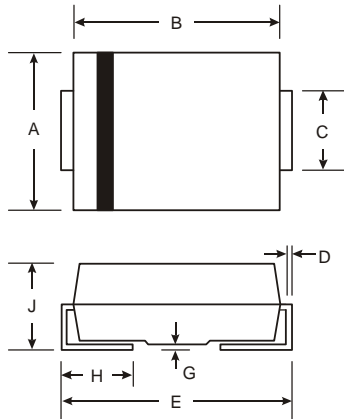
Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.

SMA



| SMA | | |
|----------------------|------|------|
| Dim | Min | Max |
| A | 2.29 | 2.92 |
| B | 4.00 | 4.60 |
| C | 1.27 | 1.63 |
| D | 0.15 | 0.31 |
| E | 4.80 | 5.59 |
| G | 0.05 | 0.20 |
| H | 0.76 | 1.52 |
| J | 1.96 | 2.40 |
| All Dimensions in mm | | |

SMB

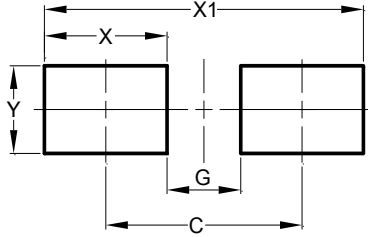


| SMB | | |
|----------------------|------|------|
| Dim | Min | Max |
| A | 3.30 | 3.94 |
| B | 4.06 | 4.57 |
| C | 1.96 | 2.21 |
| D | 0.15 | 0.31 |
| E | 5.00 | 5.59 |
| G | 0.05 | 0.20 |
| H | 0.76 | 1.52 |
| J | 2.00 | 2.50 |
| All Dimensions in mm | | |

Suggested Pad Layout

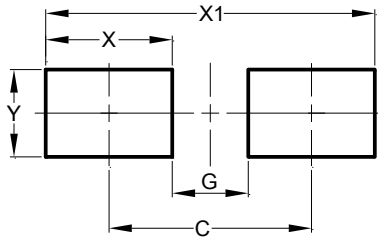
Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.

SMA



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 4.00 |
| G | 1.50 |
| X | 2.50 |
| X1 | 6.50 |
| Y | 1.70 |

SMB



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 4.30 |
| G | 1.80 |
| X | 2.50 |
| X1 | 6.80 |
| Y | 2.30 |

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